LC717A10ARGPGEVB

Capacitance-Digital-Converter LSI for Electrostatic Capacitive Touch Sensors Evaluation Board User's Manual

ON Semiconductor®

EVAL BOARD USER'S MANUAL

Introduction

This manual contains configuration, usage and main specifications regarding Electrostatic Capacitive Touch Sensor Evaluation Board (LC717A10ARGPGEVB).

For the latest edition of this manual, please refer to ON Semiconductor homepage. (http://www.onsemi.com)

Product Outline

This product is a board to have you evaluate touch sensor LSI "LC717A10AR". Because it is 600 mil width DIP shape, it is a board which it is easy to use. So it can be performed easily to evaluate one's own switch pattern.

To evaluate it, it is necessary to have an USB-to-Serial conversion module for SPI communication, the PC to operate evaluation software and any board which designed the switch pattern.

- Electrostatic Capacitive Touch Sensor Evaluation Board LC717A10ARGPGEVB
- Accessory Connector Pin (8pin)

EVALUATION BOARD

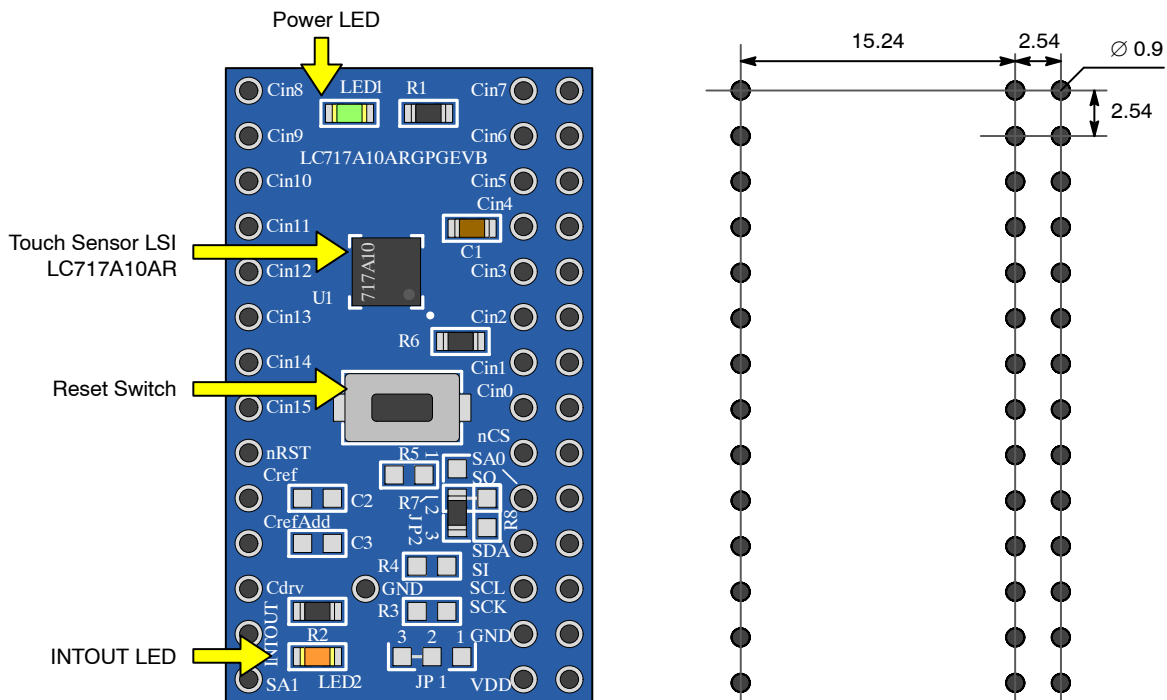**LC717A10ARGPGEVB Evaluation Board Outline**

Figure 1. Configuration of LC717A10ARGPGEVB

LC717A10ARGPGEVB

- *Touch Sensor LSI:*
  Electrostatic Capacitive Touch Sensor LSI
  LC717A10AR
- *Power LED:*
  When a power is supplied, it turns on. Power supply
  voltage is 2.6 to 5.5 V.

- *Reset Switch:*
  This is used to RESET Touch Sensor LSI. Use this
  switch if any abnormality is found during operation.
- *INTOUT LED:*
  When the INTOUT signal outputs, it turns on.
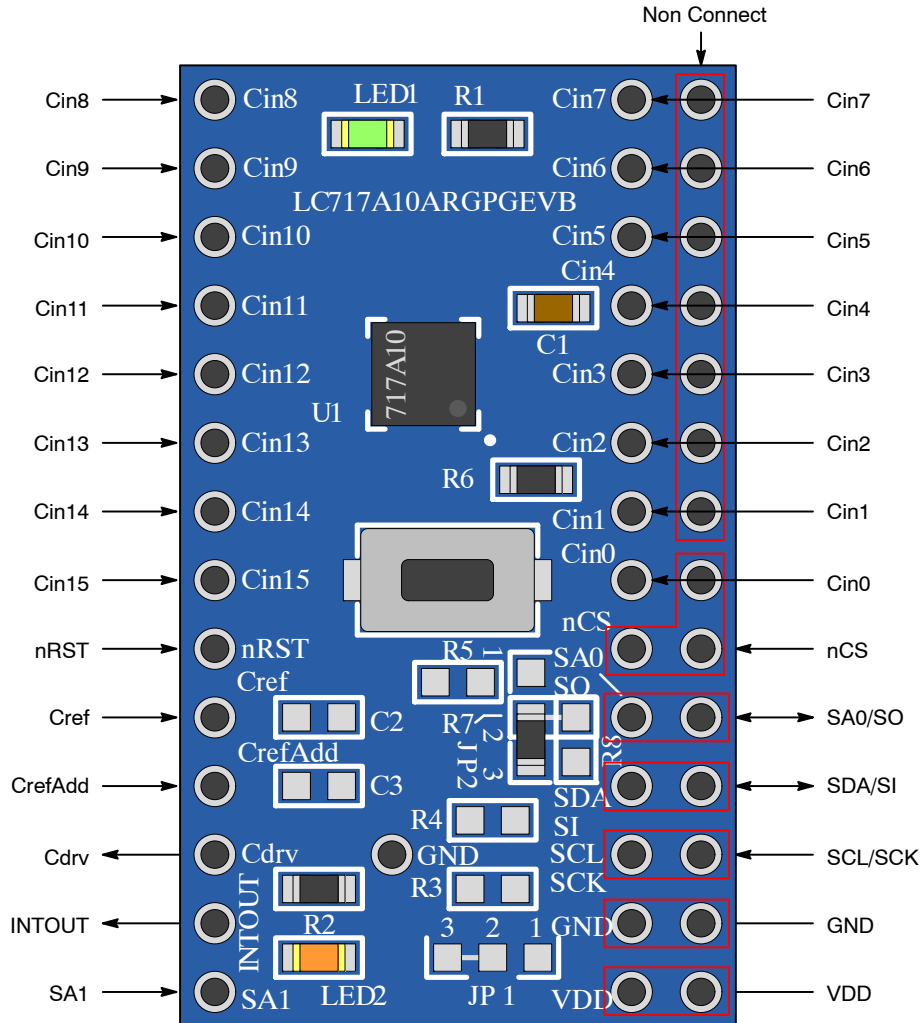
Evaluation Board Specifications

Figure 2. Terminal Pin Layout

Table 1. SIGNAL PIN FUNCTIONS

Pin Name	I/O	Pin Functions
Cin0	I/O	Capacitance Sensor Input
Cin1	I/O	Capacitance Sensor Input
Cin2	I/O	Capacitance Sensor Input
Cin3	I/O	Capacitance Sensor Input
Cin4	I/O	Capacitance Sensor Input
Cin5	I/O	Capacitance Sensor Input
Cin6	I/O	Capacitance Sensor Input
Cin7	I/O	Capacitance Sensor Input
Cin8	I/O	Capacitance Sensor Input
Cin9	I/O	Capacitance Sensor Input
Cin10	I/O	Capacitance Sensor Input
Cin11	I/O	Capacitance Sensor Input
Cin12	I/O	Capacitance Sensor Input
Cin13	I/O	Capacitance Sensor Input
Cin14	I/O	Capacitance Sensor Input
Cin15	I/O	Capacitance Sensor Input
Cref	I/O	Reference Capacitance Input
CrefAdd	I/O	Reference Capacitance Input for Addition
Cdrv	O	Output for Capacitance Sensors Drive
INTOUT	O	Interrupt Output
SCL/SCK	I	Clock Input (I^2C)/Clock Input (SPI)
nCS	I	Interface Selection/Chip Select Inverting Input (SPI)
nRST	I	External Reset Signal Inverting Input (2.2 kΩ Pull-up, with Switch)
SA1	I	Slave Address Selection (I^2C)
SDA/SI	I/O	Data Input and Output (I^2C)/Data Input (SPI)
SA0/SO	I/O	Slave Address Selection (I^2C)/Data Output (SPI) (JP2 100 kΩ Pull-down)
VDD	–	Power Supply (2.6 V to 5.5 V). It is Connected to V_{DD} of LC717A10AR
GND	–	Ground (Earth). It is Connected to V_{SS} of LC717A10AR

Table 2. MAIN SPECIFICATIONS

Parameter	Conditions	Remarks
Board Size	35.56 × 20.32 (mm)	
Board Material	Glass Epoxy (FR4)	Copper Foil: 35 μm, Thickness: 1.6 mm, 2-layer Board
Supply Voltage	2.6 to 5.5 V	
Capacitance Touch Sensor	LC717A10AR	
Communication Specification	SPI	It can be change to I^2C Compatible Bus by Parts Exchange

Table 3. JUMPER, PATTERN FOR ADDITIONAL PARTS

Pattern	Parameter	Set Contents
C2	Pattern for Cref Capacity Adjustment	Implement capacitor of any capacity as needed. (Size: 1608)
C3	Pattern for CrefAdd Capacity Adjustment	Implement capacitor of any capacity as needed. (Size: 1608)
R3	Pattern for SCL Pull-up	When I^{2}C compatible bus is chosen by nCS, implement a resistance of 2.2 kΩ. (Size: 1608) (Pull-up VDD)
R4	Pattern for SDA Pull-up	When I^{2}C compatible bus is chosen by nCS, implement a resistance of 2.2 kΩ. (Size: 1608) (Pull-up VDD)
R5	Pattern for nCS Pull-up	When I^{2}C compatible bus is chosen by nCS, implement a resistance of 2.2 kΩ. (Size: 1608) (Pull-up VDD)
R7	Reserve Pattern	(R7 Initialization: Short) (Size: 1608)
R8	Reserve Pattern	(R8 Initialization: Open) (Size: 1608)

JP1	Pattern for I^{2}C Compatible Bus Slave Address Selection	When I^{2}C compatible bus is chosen by nCS, set the I^{2}C compatible bus slave address by JP1 and JP2. When SPI is chosen, connect to the ground. (JP1 Initialization: Ground Short)
		  1–2 Short: H Level
		  2–3 Short: L Level

JP2	Pattern for I^{2}C Compatible Bus Slave Address Selection/SO Pull-down	When I^{2}C compatible bus is chosen by nCS, set the I^{2}C compatible bus slave address by JP1 and JP2. When SPI is chosen, implement a resistance of 100 kΩ between 2 to 3. (It has been implemented.) (JP2 Initialization: Ground Pull-down)
		  1–2 Short: H Level
		  2–3 Short: L Level

Table 4. LC717A10AR I^{2}C COMPATIBLE BUS SLAVE ADDRESS

SA1 Input (JP1)	SA0 Input (JP2)	7bit Slave Address	Binary Notation	8bit Slave Address
Low	Low	0x16	00101100b (Write)	0x2C
			00101101b (Read)	0x2D
Low	High	0x17	00101110b (Write)	0x2E
			00101111b (Read)	0x2F
High	Low	0x18	00110000b (Write)	0x30
			00110001b (Read)	0x31
High	High	0x19	00110010b (Write)	0x32
			00110011b (Read)	0x33

HOW TO USE

1. Connection of connector pin.
   Solder attached connector pin (8pin) at the position of the Figure 3.
2. Connect LC717A10ARGPGEVB to the board which designed the switch pattern.
   When design the switch pattern, please refer to the User's manual and FAQ pages in "http://www.sanyosemi.com/en/touch-sensor/index.php".
3. Connect LC717A10ARGPGEVB to PC through an USB-to-Serial conversion module. Supply the power, and verify the Power LED is turned on.
4. Install evaluation software to PC. Evaluation software is able to download from "http://www.sanyosemi.com/en/touch-sensor/index.php". Double-click to the icon "LC717A10App.exe" in the folder installed, and start it. Please refer to "LC717A10 demo application soft user's manual".
5. Press RESET Switch when evaluation board is acting strange.
6. Please note: If the user directly touches the LSI on the evaluation board or patterns with their finger, it may cause malfunction or breakdown.
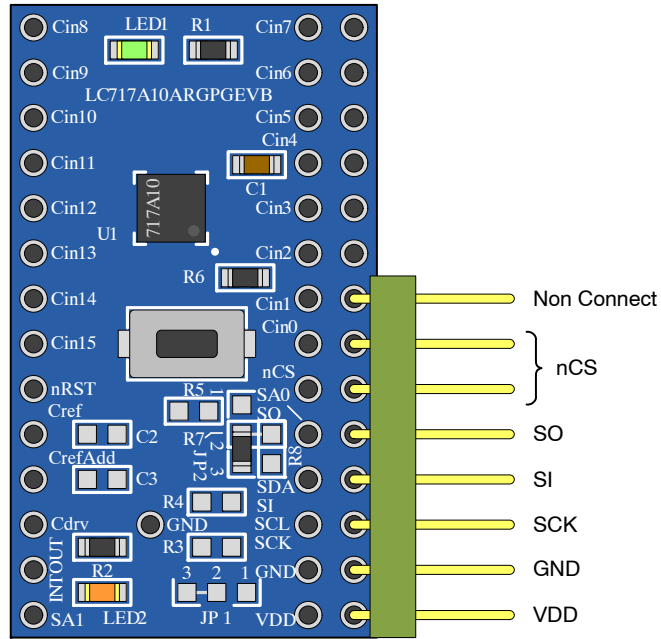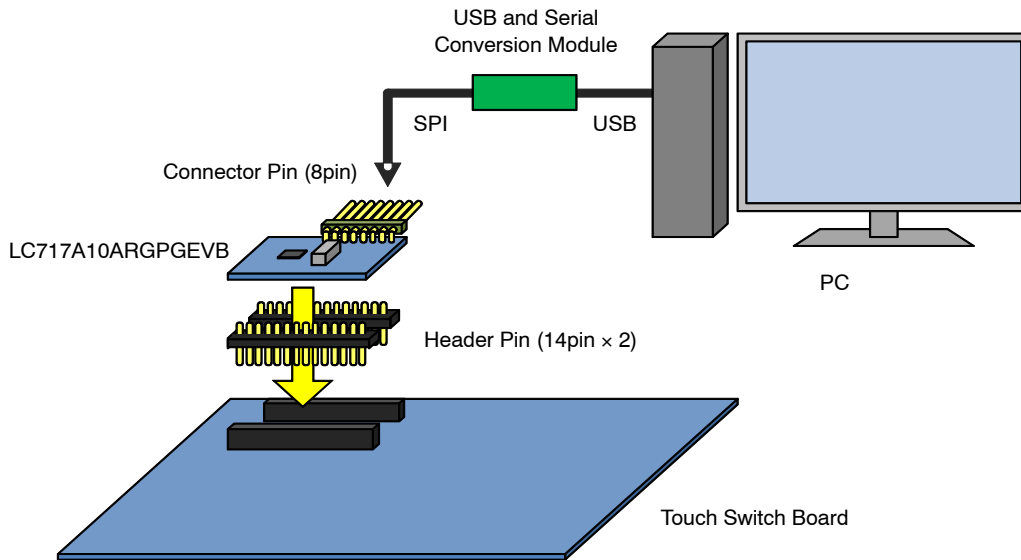
Figure 3. Connection of Connector Pin

(Other than LC717A10ARGPGEVB and Connector Pin (8pin) are not Attached.)

Figure 4. Connection Example of LC717A10ARGPGEVB
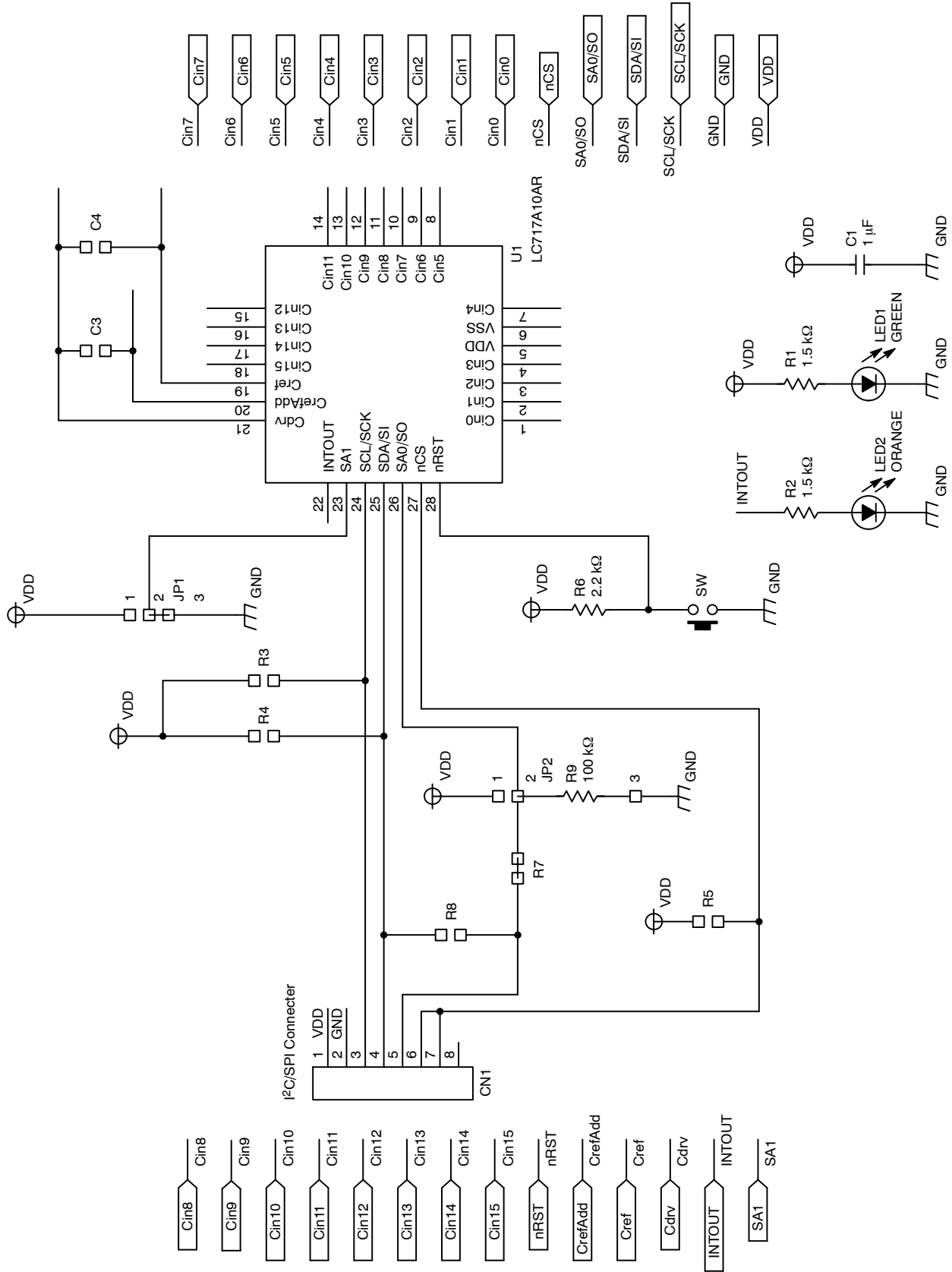
CIRCUIT DIAGRAMS

Figure 5. Circuit Diagrams

LC717A10ARGPGEVB

PRECAUTION FOR USE

For approach in the use of LSI and the design rule of the switch pattern: Please refer to the User's manual and FAQ pages in ON Semiconductor homepage.

Touch sensor introduction page URL
http://www.sanyosemi.com/en/touch-sensor/index.php

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